503816617 05/09/2016

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHUNPEI YAMAZAKI	07/15/2010
HIROKI OHARA	07/15/2010
TOSHINARI SASAKI	07/15/2010
KOSEI NODA	07/15/2010
HIDEAKI KUWABARA	07/15/2010

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15063664

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	JANELLE A. JACKSON
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DATE SIGNED:	05/09/2016

Total Attachments: 2

PATENT REEL: 038507 FRAME: 0353

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PATENT REEL: 038507 FRAME: 0354

ASSIGNMENT

For valuable consideration, We, Shunpei YAMAZAKI of Setagaya, Tokyo, Japan, Hiroki OHARA of Sagamihara, Kanagawa, Japan, Toshinari SASAKI of Atsugi, Kanagawa, Japan, Kosei NODA of Atsugi, Kanagawa, Japan and Hideaki KUWABARA of Isehara, Kanagawa, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a Japanese corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE AND METHOD FOR
MANUFACTURING THE SAME, filed July 29, 2010 , and assigned U.S. Serial
Number 12/846,534, and we authorize and request the attorneys appointed in said application
to hereafter complete this assignment by inserting above the filing date and serial number of said application
when known; this assignment including said application, any and all United States and foreign patents, utility
models, and design registrations granted for any of said inventions or improvements, and the right to claim
priority based on the filing date of said application under the International Convention for the Protection of
Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of
like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for
patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said
inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and
assigns, without further compensation to perform such lawful acts and to sign such further applications,
assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to
effectuate fully this assignment.

Signature
Name: Shunpei AMAZAKI

Date: 01/15/2010

Signature Airika Chara

Name: Hiroki OHARA

Date: 07/15/2010

PATENT REEL: 038507 FRAME: 0355 Signature
Name: Toshinari SASAKI
Date: 07/15/2010

Signature
Kosei NODA
Date: c7/15/2010

Signature
Name: Hideaki KUWABARA
Date: 07/15/2010

RECORDED: 05/09/2016

PATENT REEL: 038507 FRAME: 0356